

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| In re Application of: |) |
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| Young-Hee JUNG |) Confirmation No.: 9496 |
| Application No.: 10/682,081 |) Group Art Unit: 2815 |
| Filed: October 10, 2003 |) Examiner: S. Clark |
| For: HIGH-DENSITY CHIP SC PACKAGE AND METHOI MANUFACTURING THE | OF) |

Commissioner for Patents U.S. Patent and Trademark Office Mail Stop Amendment Alexandria, VA 22314

Sir:

AMENDMENT

In response to the Office Action dated March 25, 2005, the period for response to which extends through June 27, 2005 (June 25, 2005 being a Saturday), please amend the above-identified application as follows: